

32K 2.5V CMOS Serial EEPROM

FEATURES

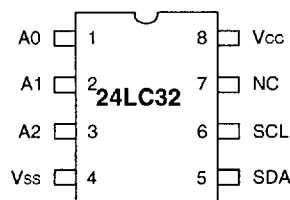
- Voltage operating range: 2.5V to 6.0V
 - Peak write current 3 mA at 6.0V
 - Maximum read current 150 μ A at 6.0V
 - Standby current 1 μ A typical
- Industry standard two-wire bus protocol, I²C™ compatible
 - Including 100 kHz (2.5V) and 400 kHz (5V) modes
- Self-timed ERASE and WRITE cycles
- Power on/off data protection circuitry
- Endurance:
 - **10,000,000 ERASE/WRITE cycles guaranteed for High Endurance Block**
 - **100,000 E/W cycles guaranteed for Standard Endurance Block**
- 8 byte page, or byte modes available
- 1 page x 8 line input cache (64 bytes) for fast write loads
- Schmitt trigger, filtered inputs for noise suppression
- Output slope control to eliminate ground bounce
- 2 ms typical write cycle time, byte or page
- Factory programming (QTP) available
- Up to 8 devices may be connected to the same bus for up to 256K bits total memory
- Electrostatic discharge protection > 4000V
- Data retention > 200 years
- 8-pin PDIP/SOIC packages
- Temperature ranges:
 - Commercial: 0°C to +70°C
 - Industrial: -40°C to +85°C

DESCRIPTION

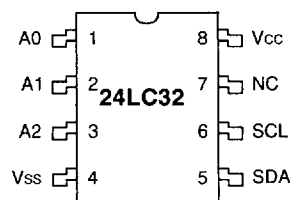
The Microchip Technology Inc. 24LC32 is a 4K x 8 (32K bit) Serial Electrically Erasable PROM capable of operation across a broad voltage range (2.5V to 6.0V). This device has been developed for advanced, low power applications such as personal communications or data acquisition. The 24LC32 features an input cache for fast write loads with a capacity of eight 8-byte pages, or 64 bytes. It also features a fixed 4K-bit block of ultra-high endurance memory for data that changes frequently. The 24LC32 is capable of both random and sequential reads up to the 32K boundary. Functional address lines allow up to 8 - 24LC32 devices on the same bus, for up to 256K bits address space. Advanced CMOS technology and broad voltage range make this device ideal for low-power/low voltage, non-volatile code and data applications. The 24LC32 is available in the standard 8-pin plastic DIP and 8-pin surface mount SOIC package.

PACKAGE TYPE

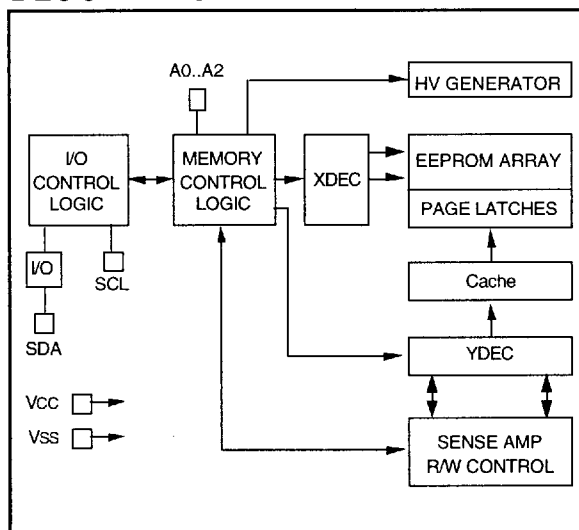
PDIP



SOIC



BLOCK DIAGRAM



I²C is a trademark of Philips Corporation

ELECTRICAL CHARACTERISTICS

1.1 Maximum Ratings*

Vcc..... 7.0V

All inputs and outputs w.r.t. Vss -0.6V to Vcc +1.0V

Storage temperature -65°C to +150°C

Ambient temp. with power applied -65°C to +125°C

Soldering temperature of leads (10 seconds) ...+300°C

ESD protection on all pins ≥ 4 kV

*Notice: Stresses above those listed under "Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operational listings of this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

TABLE 1-1: PIN FUNCTIONS

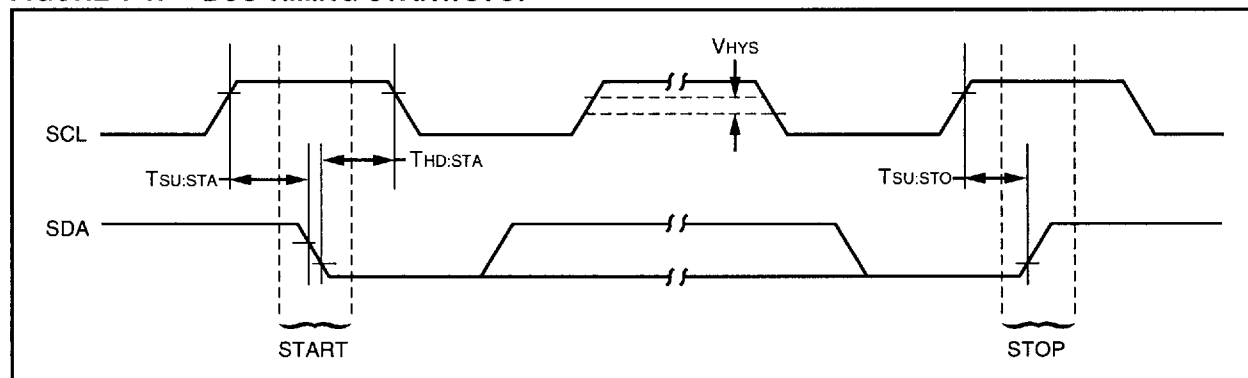
Name	Function
A0..A2	User Configurable Chip Selects
Vss	Ground
SDA	Serial Address/Data I/O
SCL	Serial Clock
Vcc	+2.5V to 6.0V Power Supply
NC	No Internal Connection

TABLE 1-2: DC CHARACTERISTICS

Vcc = +2.5V to 6.0V Commercial (C): Tamb = 0°C to +70°C Industrial (I): Tamb = -40°C to +85°C					
Parameter	Symbol	Min	Max	Units	Conditions
A0, A1, A2, SCL and SDA pins:					
High level input voltage	V _{IH}	.7 Vcc	—	V	
Low level input voltage	V _{IL}	—	.3 Vcc	V	
Hysteresis of Schmitt Trigger inputs	V _{HYS}	.05 Vcc	—	V	Note 1
Low level output voltage	V _{OL}	—	.40	V	I _{OL} = 3.0 mA
Input leakage current	I _{LI}	-10	10	μA	V _{IN} = .1V to Vcc
Output leakage current	I _{LO}	-10	10	μA	V _{OUT} = .1V to Vcc
Pin capacitance (all inputs/outputs)	C _{IN} , C _{OUT}	—	10	pF	Vcc = 5.0V (Note 1) Tamb = 25°C, Fclk = 1 MHz
Operating current	I _{CC} Write I _{CC} Read	— —	3 150	mA μA	Vcc = 6.0V, SCL = 400 kHz Vcc = 6.0V, SCL = 400 kHz
Standby current	I _{CCS}	—	5	μA	Vcc = 5.0V, SCL = SDA = Vcc Note 1

Note 1: This parameter is periodically sampled and not 100% tested.

FIGURE 1-1: BUS TIMING START/STOP



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AC CHARACTERISTICS

Parameter	Symbol	V _{CC} = 2.5V-6.0V STD. MODE		V _{CC} = 4.5 - 6.0V FAST MODE		Units	Remarks
		Min	Max	Min	Max		
Clock frequency	F _{CLK}	—	100	—	400	kHz	
Clock high time	T _{HIGH}	4000	—	600	—	ns	
Clock low time	T _{LOW}	4700	—	1300	—	ns	
SDA and SCL rise time	T _R	—	1000	—	300	ns	Note 1
SDA and SCL fall time	T _F	—	300	—	300	ns	Note 1
START condition hold time	T _{HD:STA}	4000	—	600	—	ns	After this period the first clock pulse is generated
START condition setup time	T _{SU:STA}	4700	—	600	—	ns	Only relevant for repeated START condition
Data input hold time	T _{HD:DAT}	0	—	0	—	ns	
Data input setup time	T _{SU:DAT}	250	—	100	—	ns	
STOP condition setup time	T _{SU:STO}	4000	—	600	—	ns	
Output valid from clock	T _{AA}	—	3500	—	900	ns	Note 2
Bus free time	T _{BUF}	4700	—	1300	—	ns	Time the bus must be free before a new transmission can start
Output fall time from V _{IH} min to V _{IL} max	T _{OF}	—	250	20 + 0.1 C _B	250	ns	Note 1, C _B ≤ 100 pF
Input filter spike suppression (SDA and SCL pins)	T _{SP}	—	50	—	50	ns	Note 3
Write cycle time	T _{WR}	—	5	—	5	ms/page	Note 4

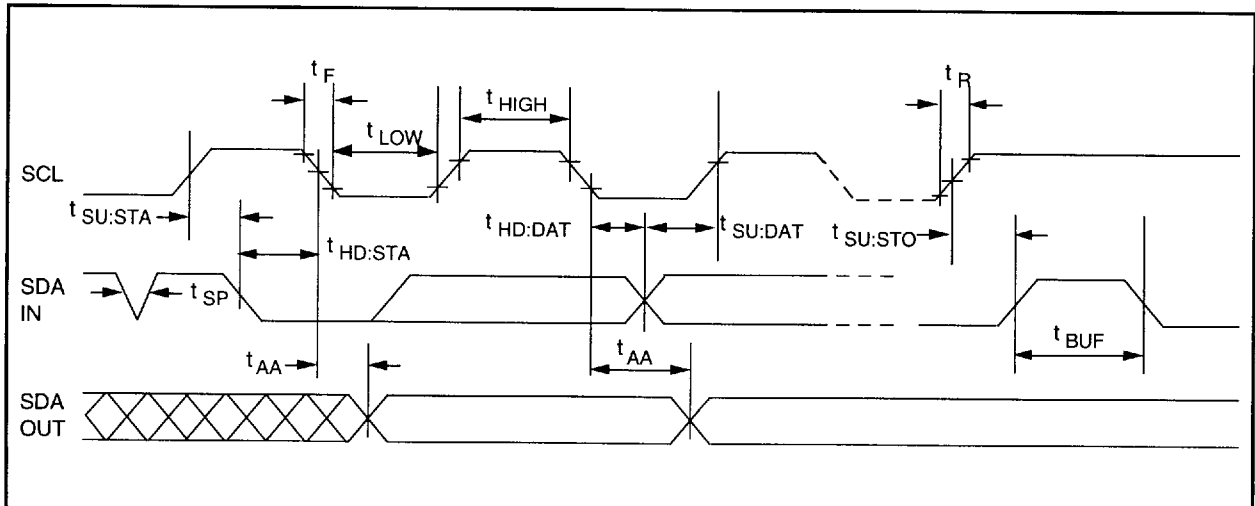
Note 1: Not 100% tested. C_B = total capacitance of one bus line in pF.

Note 2: As a transmitter, the device must provide an internal minimum delay time to bridge the undefined region (minimum 300 ns) of the falling edge of SCL to avoid unintended generation of START or STOP conditions.

Note 3: The combined T_{SP} and V_{HYS} specifications are due to new Schmitt trigger inputs which provide improved noise and spike suppression. This eliminates the need for a T_i specification for standard operation.

Note 4: The times shown are for a single page of 8 bytes. Multiply by the number of pages loaded into the write cache for total time.

FIGURE 1-2: BUS TIMING DATA



2.0 FUNCTIONAL DESCRIPTION

The 24LC32 supports a bidirectional two-wire bus and data transmission protocol. A device that sends data onto the bus is defined as transmitter, and a device receiving data as receiver. The bus must be controlled by a master device which generates the serial clock (SCL), controls the bus access, and generates the START and STOP conditions, while the 24LC32 works as slave. Both master and slave can operate as transmitter or receiver but the master device determines which mode is activated.

3.0 BUS CHARACTERISTICS

The following **bus protocol** has been defined:

- Data transfer may be initiated only when the bus is not busy.
- During data transfer, the data line must remain stable whenever the clock line is HIGH. Changes in the data line while the clock line is HIGH will be interpreted as a START or STOP condition.

Accordingly, the following bus conditions have been defined (See Figure 3-1).

3.1 Bus not Busy (A)

Both data and clock lines remain HIGH.

3.2 Start Data Transfer (B)

A HIGH to LOW transition of the SDA line while the clock (SCL) is HIGH determines a START condition. All commands must be preceded by a START condition.

3.3 Stop Data Transfer (C)

A LOW to HIGH transition of the SDA line while the clock (SCL) is HIGH determines a STOP condition. All operations must be ended with a STOP condition.

3.4 Data Valid (D)

The state of the data line represents valid data when, after a START condition, the data line is stable for the duration of the HIGH period of the clock signal.

The data on the line must be changed during the LOW period of the clock signal. There is one clock pulse per bit of data.

Each data transfer is initiated with a START condition and terminated with a STOP condition. The number of the data bytes transferred between the START and STOP conditions is determined by the master device.

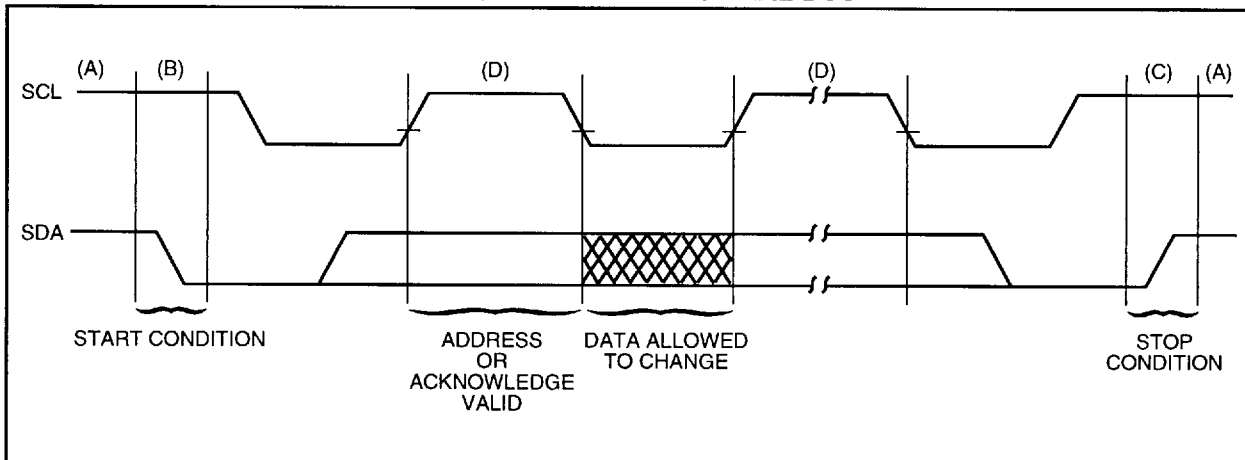
3.5 Acknowledge

Each receiving device, when addressed, is obliged to generate an acknowledge signal after the reception of each byte. The master device must generate an extra clock pulse which is associated with this acknowledge bit.

Note: The 24LC32 does not generate any acknowledge bits if an internal programming cycle is in progress.

A device that acknowledges must pull down the SDA line during the acknowledge clock pulse in such a way that the SDA line is stable LOW during the HIGH period of the acknowledge related clock pulse. Of course, setup and hold times must be taken into account. During reads, a master must signal an end of data to the slave by NOT generating an acknowledge bit on the last byte that has been clocked out of the slave. In this case, the slave (24LC32) will leave the data line HIGH to enable the master to generate the STOP condition.

FIGURE 3-1: DATA TRANSFER SEQUENCE ON THE SERIAL BUS



4.0 BUS CHARACTERISTICS

4.1 Device Addressing and Operation (Figure 4-1)

A control byte is the first byte received following the start condition from the master device. The control byte consists of a four bit control code; for the 24LC32 this is set as 1010 binary for read and write operations. The next three bits of the control byte are the device select bits (A2, A1, A0). They are used by the master device to select which of the eight devices are to be accessed. These bits are in effect the three most significant bits of the word address. The last bit of the control byte defines the operation to be performed. When set to a one a read operation is selected, and when set to a zero a write operation is selected. The next two bytes received define the address of the first data byte (see Figure 4-2). Because only A11...A0 are used, the upper four address bits must be zeros. The most significant bit of the most significant byte of the address is transferred first.

Following the start condition, the 24LC32 monitors the SDA bus checking the device type identifier being transmitted. Upon receiving a 1010 code and appropriate device select bits, the slave device outputs an acknowledge signal on the SDA line. Depending on the state of the R/W bit, the 24LC32 will select a read or write operation.

Operation	Control Code	Device Select	R/W
Read	1010	Device Address	1
Write	1010	Device Address	0

FIGURE 4-1: CONTROL BYTE ALLOCATION

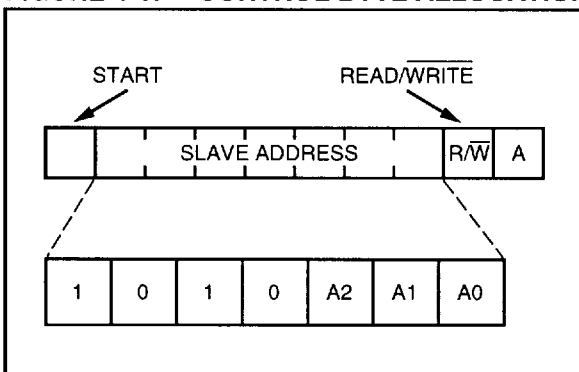
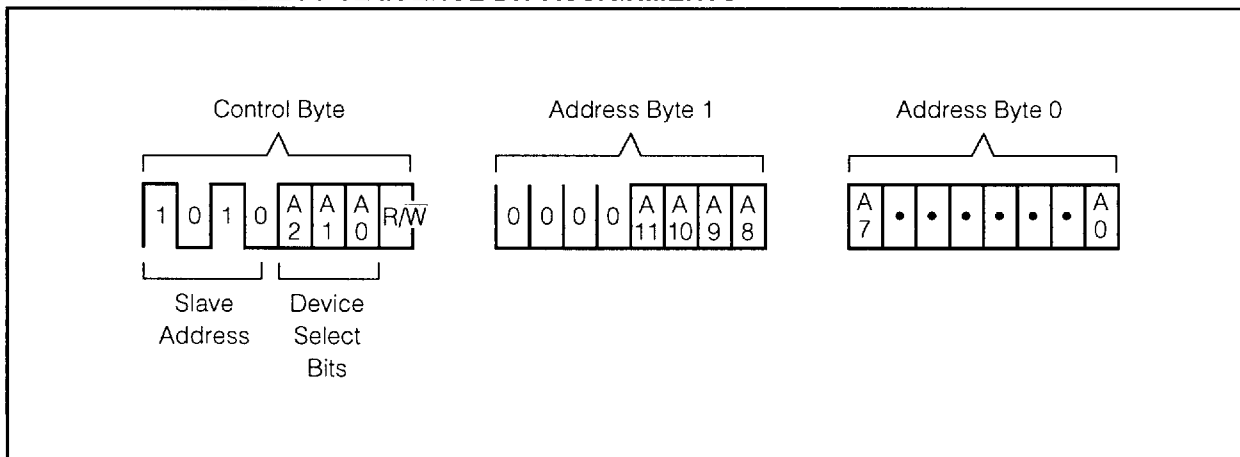


FIGURE 4-2: ADDRESS SEQUENCE BIT ASSIGNMENTS



5.0 WRITE OPERATION

5.1 Split Endurance

The 24LC32 is organized as a continuous 32K block of memory. However, the first 4K, starting at address 000, is rated at 10,000,000 E/W cycles guaranteed. The remainder of the array, 28K bits, is rated at 100,000 E/W cycles guaranteed. This feature is helpful in applications in which some data change frequently, while a majority of the data change infrequently. One example would be a cellular telephone in which last-number redial and microcontroller scratch pad require a high-endurance block, while speed dials and lookup tables change infrequently and so require only a standard endurance rating.

5.2 Byte Write

Following the start condition from the master, the control code (four bits), the device select (three bits), and the R/W bit which is a logic low are clocked onto the bus by the master transmitter. This indicates to the addressed slave receiver that a byte with a word address will follow after it has generated an acknowledge bit during the ninth clock cycle. Therefore the next byte transmitted by the master is the high-order byte of the word address and will be written into the address pointer of the 24LC32. The next byte is the least significant address byte. After receiving another acknowledge signal from the 24LC32 the master device will transmit the data word to be written into the addressed memory location.

The 24LC32 acknowledges again and the master generates a stop condition. This initiates the internal write cycle, and during this time the 24LC32 will not generate acknowledge signals (see Figure 5-1).

5.3 Page Write

The write control byte, word address and the first data byte are transmitted to the 24LC32 in the same way as in a byte write. But instead of generating a stop condition, the master transmits up to eight pages of eight data bytes each (64 bytes total) which are temporarily stored in the on-chip page cache of the 24LC32. They will be written from cache into the EEPROM array after the master has transmitted a stop condition. After the receipt of each word, the six lower order address pointer bits are internally incremented by one. The higher order seven bits of the word address remain constant. If the master should transmit more than eight bytes prior to generating the stop condition (writing across a page boundary), the address counter (lower three bits) will roll over and the pointer will be incremented to point to the next line in the cache. This can continue to occur up to eight times or until the cache is full, at which time a stop condition should be generated by the master. If a stop condition is not received, the cache pointer will roll over to the first line (byte 0) of the cache, and any further data received will overwrite previously captured data. The stop condition can be sent at any time during the transfer. As with the byte write operation, once a stop condition is received, an internal write cycle will begin. The 64-byte cache will continue to capture data until a stop condition occurs or the operation is aborted (see Figure 5-2).

FIGURE 5-1: BYTE WRITE

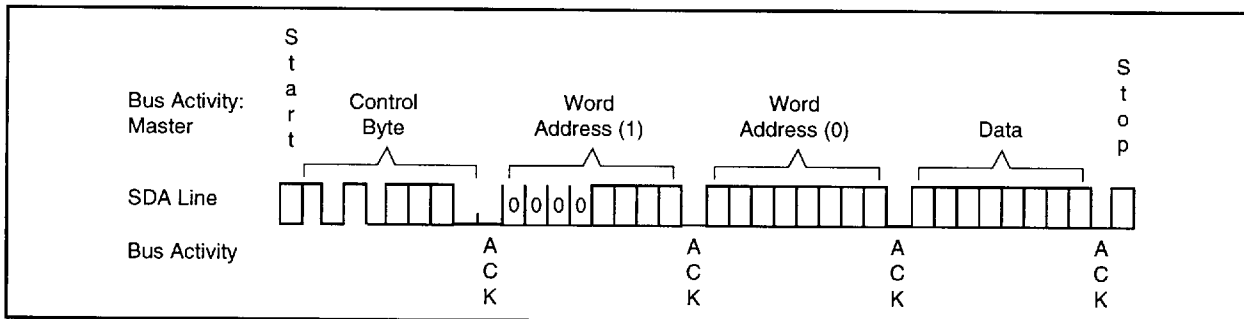
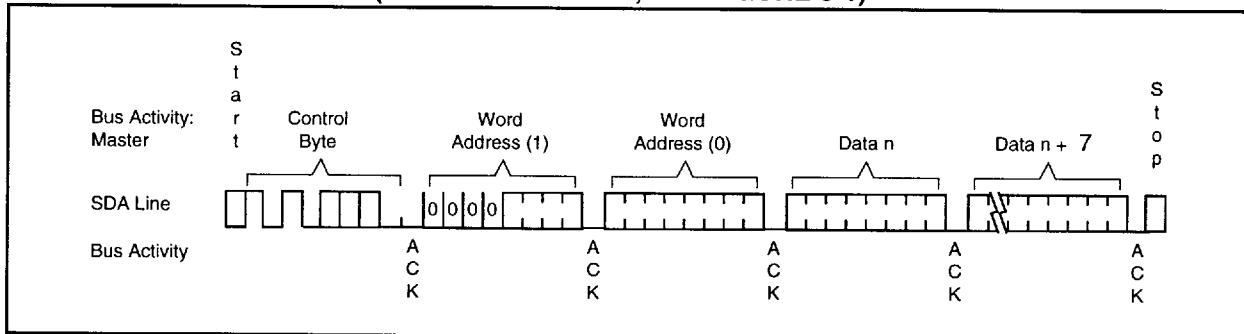


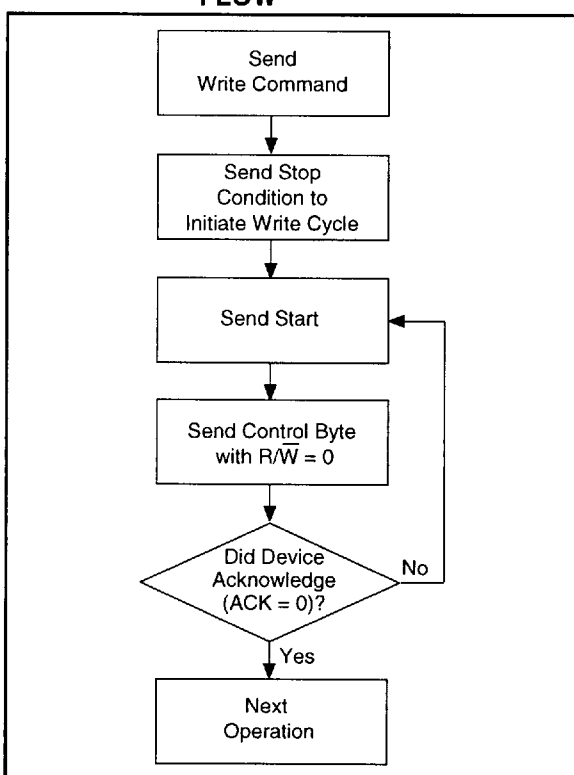
FIGURE 5-2: PAGE WRITE (FOR CACHE WRITE, SEE FIGURE 8-1)



6.0 ACKNOWLEDGE POLLING

Since the device will not acknowledge during a write cycle, this can be used to determine when the cycle is complete (this feature can be used to maximize bus throughput). Once the stop condition for a write command has been issued from the master, the device initiates the internally timed write cycle. ACK polling can be initiated immediately. This involves the master sending a start condition followed by the control byte for a write command ($R/\bar{W} = 0$). If the device is still busy with the write cycle, then no ACK will be returned. If the cycle is complete, then the device will return the ACK and the master can then proceed with the next read or write command. See Figure 6-1 for flow diagram.

FIGURE 6-1: ACKNOWLEDGE POLLING FLOW



7.0 READ OPERATION

Read operations are initiated in the same way as write operations with the exception that the $R/\bar{W}$ bit of the slave address is set to one. There are three basic types of read operations: current address read, random read, and sequential read.

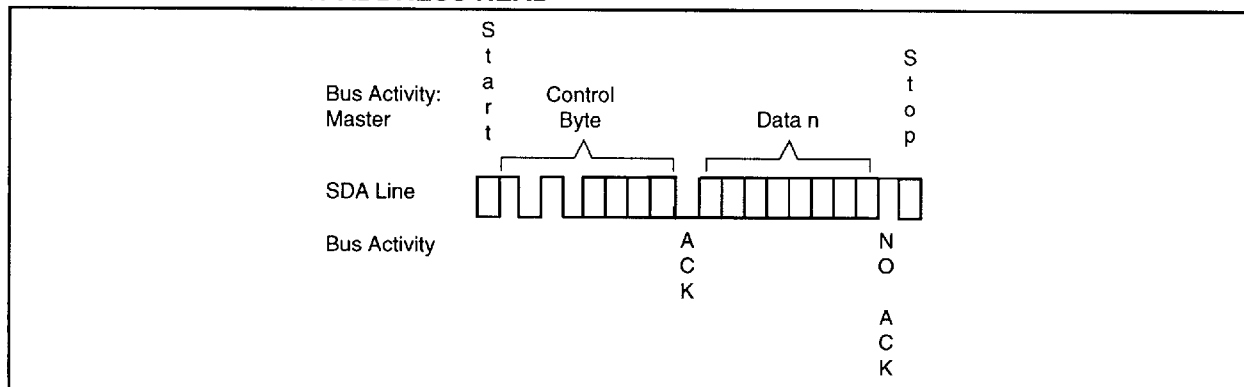
7.1 Current Address Read

The 24LC32 contains an address counter that maintains the address of the last word accessed, internally incremented by one. Therefore, if the previous access (either a read or write operation) was to address n (n is any legal address), the next current address read operation would access data from address $n + 1$. Upon receipt of the slave address with $R/\bar{W}$ bit set to one, the 24LC32 issues an acknowledge and transmits the eight bit data word. The master will not acknowledge the transfer but does generate a stop condition and the 24LC32 discontinues transmission (see Figure 7-1).

7.2 Random Read

Random read operations allow the master to access any memory location in a random manner. To perform this type of read operation, first the word address must be set. This is done by sending the word address to the 24LC32 as part of a write operation ($R/\bar{W}$ bit set to 0). After the word address is sent, the master generates a start condition following the acknowledge. This terminates the write operation, but not before the internal address pointer is set. Then the master issues the control byte again but with the $R/\bar{W}$ bit set to a one. The 24LC32 will then issue an acknowledge and transmit the eight bit data word. The master will not acknowledge the transfer but does generate a stop condition which causes the 24LC32 to discontinue transmission (see Figure 7-2).

FIGURE 7-1: CURRENT ADDRESS READ



查询"24LC32"供应商 3. Contiguous Addressing Across Multiple Devices

The device select bits A2, A1, A0 can be used to expand the contiguous address space for up to 256K bits by adding up to eight 24LC32's on the same bus. In this case, software can use A0 of the control byte as address bit A12, A1 as address bit A13, and A2 as address bit A14.

7.4 Sequential Read

Sequential reads are initiated in the same way as a random read except that after the 24LC32 transmits the first data byte, the master issues an acknowledge as opposed to the stop condition used in a random read. This acknowledge directs the 24LC32 to transmit the next sequentially addressed 8 bit word (see Figure 7-3). Following the final byte transmitted to the master, the master will NOT generate an acknowledge but will generate a stop condition.

To provide sequential reads the 24LC32 contains an internal address pointer which is incremented by one at the completion of each operation. This address pointer allows the entire memory contents to be serially read during one operation. The address pointer, however, will not roll over from address 07FF to address 0000. It will roll from 07FF to unused memory space.

7.5 Noise Protection

The SCL and SDA inputs have filter circuits which suppress noise spikes to ensure proper device operation even on a noisy bus. All I/O lines incorporate Schmitt triggers for 400 kHz (Fast Mode) compatibility.

FIGURE 7-2: RANDOM READ

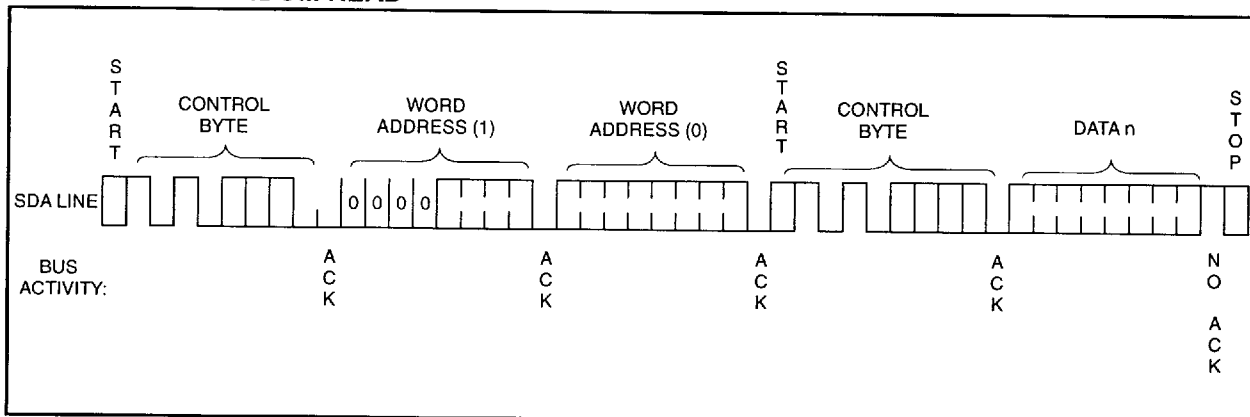
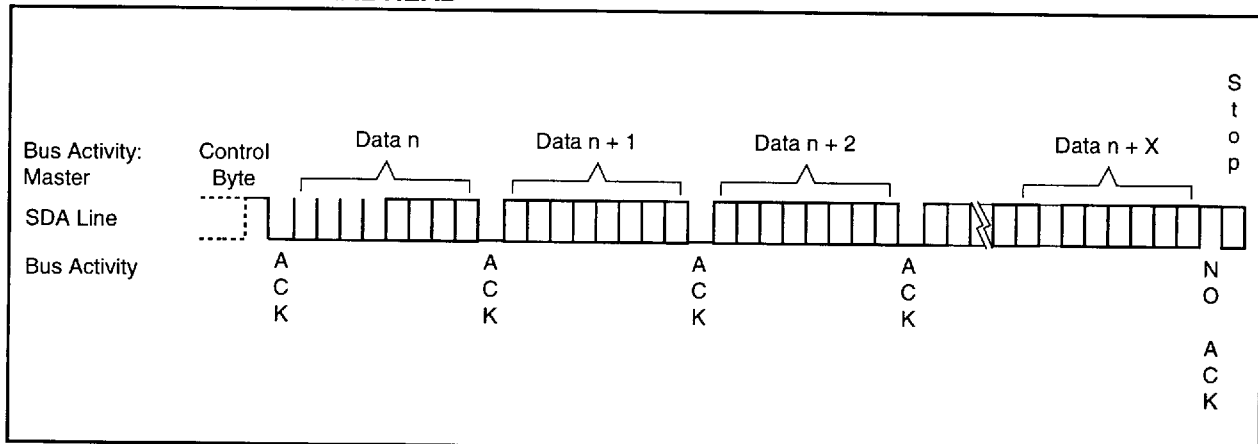


FIGURE 7-3: SEQUENTIAL READ



7.6 PAGE CACHE AND ARRAY MAPPING

The cache is a 64 byte (8 pages x 8 bytes) FIFO buffer. The cache allows the loading of up to 64 bytes of data before the write cycle is actually begun, effectively providing a 64-byte burst write at the maximum bus rate. Whenever a write command is initiated, the cache starts loading and will continue to load until a stop bit is received to start the internal write cycle. The total length of the write cycle will depend on how many pages are loaded into the cache before the stop bit is given. Maximum cycle time for each page is 5 ms. Even if a page is only partially loaded, it will still require the same cycle time as a full page. If more than 64 bytes of data are loaded before the stop bit is given, the address pointer will 'wrap around' to the beginning of cache page 0 and existing bytes in the cache will be overwritten. The device will not respond to any commands while the write cycle is in progress.

7.7 Cache Write Starting at a Page Boundary

If a write command begins at a page boundary (address bits A2, A1 and A0 are zero), then all data loaded into the cache will be written to the array in sequential addresses. This includes writing across a 4K block boundary. In the example shown below, (see Figure 5-2) a write command is initiated starting at byte 0 of page 3 with a fully loaded cache (64 bytes). The first byte in the cache is written to byte 0 of page 3 (of the array), with the remaining pages in the cache written to sequential pages in the array. A write cycle is executed after each page is written. Since the write begins at page 3 and 8 pages are loaded into the cache, the last 3 pages of the cache are written to the next row in the array.

7.8 Cache Write Starting at a Non-Page Boundary

When a write command is initiated that does not begin at a page boundary (i.e., address bits A2, A1 and A0 are not all zero), it is important to note how the data is loaded into the cache, and how the data in the cache is written to the array. When a write command begins, the first byte loaded into the cache is always loaded into page 0. The byte within page 0 of the cache where the load begins is determined by the three least significant address bits (A2, A1, A0) that were sent as part of the write command. If the write command does not start at byte 0 of a page and the cache is fully loaded, then the last byte(s) loaded into the cache will roll around to page 0 of the cache and fill the remaining empty bytes. If more than 64 bytes of data are loaded into the cache, data already loaded will be overwritten. In the example shown in Figure 8-2, a write command has been initiated starting at byte 2 of page 3 in the array with a fully loaded cache of 64 bytes. Since the cache started loading at byte 2, the last two bytes loaded into the cache will 'roll over' and be loaded into the first two

bytes of page 0 (of the cache). When the stop bit is sent, page 0 of the cache is written to page 3 of the array. The remaining pages in the cache are then loaded sequentially to the array. A write cycle is executed after each page is written. If a partially loaded page in the cache remains when the STOP bit is sent, only the bytes that have been loaded will be written to the array.

7.9 Power Management

This design incorporates a power standby mode when the device is not in use and automatically powers off after the normal termination of any operation when a stop bit is received and all internal functions are complete. This includes any error conditions, i.e. not receiving an acknowledge or stop condition per the two-wire bus specification. The device also incorporates VDD monitor circuitry to prevent inadvertent writes (data corruption) during low-voltage conditions. The VDD monitor circuitry is powered off when the device is in standby mode in order to further reduce power consumption.

8.0 PIN DESCRIPTIONS

8.1 A0, A1, A2 Chip Address Inputs

The A0..A2 inputs are used by the 24LC32 for multiple device operation and conform to the two-wire bus standard. The levels applied to these pins define the address block occupied by the device in the address map. A particular device is selected by transmitting the corresponding bits (A2, A1, A0) in the control byte (see Figure 4-2).

8.2 SDA Serial Address/Data Input/Output

This is a bidirectional pin used to transfer addresses and data into and data out of the device. It is an open drain terminal, therefore the SDA bus requires a pullup resistor to VCC (typical 10KΩ for 100 kHz, 1KΩ for 400 kHz)

For normal data transfer SDA is allowed to change only during SCL low. Changes during SCL high are reserved for indicating the START and STOP conditions.

8.3 SCL Serial Clock

This input is used to synchronize the data transfer from and to the device.

FIGURE 8-1: CACHE WRITE TO THE ARRAY STARTING AT A PAGE BOUNDARY

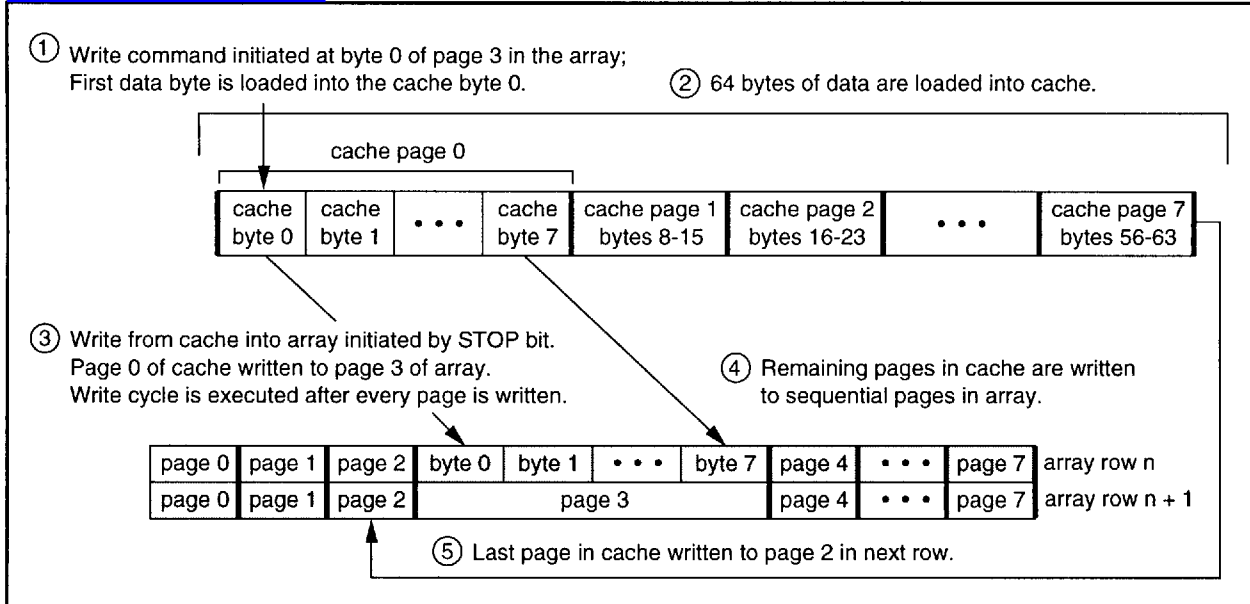
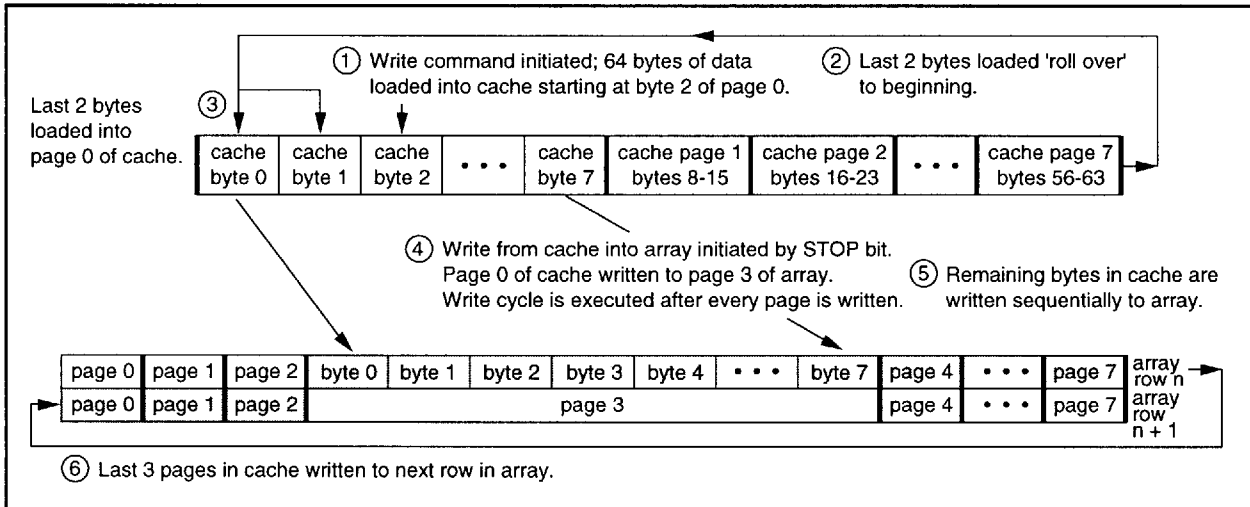


FIGURE 8-2: CACHE WRITE TO THE ARRAY STARTING AT A NON-PAGE BOUNDARY

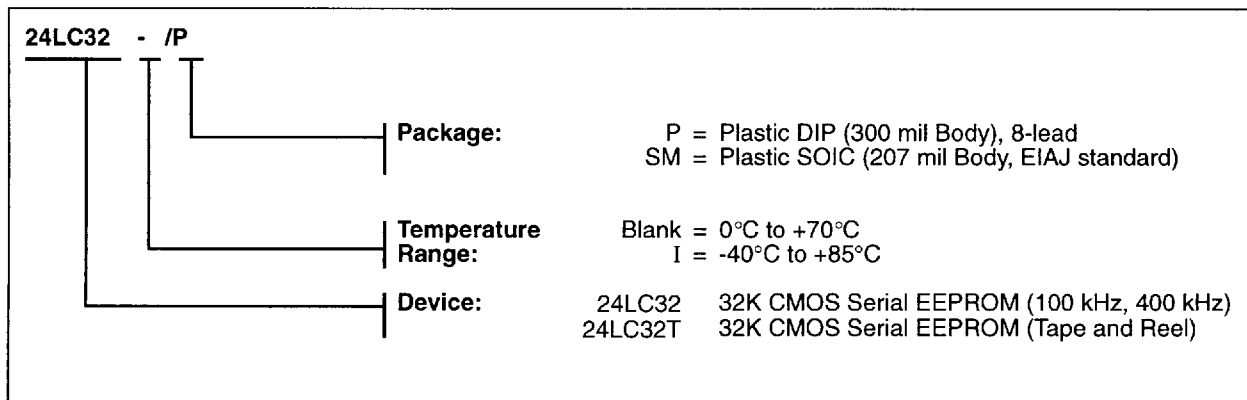


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24LC32

24LC32 Product Identification System

To order or to obtain information, e.g., on pricing or delivery, please use the listed part numbers, and refer to the factory or the listed sales offices.



AMERICAS

Corporate Office

Microchip Technology Inc.
2355 West Chandler Blvd.
Chandler, AZ 85224-6199
Tel: 602 786-7200 Fax: 602 786-7277
Technical Support: 602 786-7627
Web: <http://www.mchip.com/biz/mchip>

Atlanta

Microchip Technology Inc.
500 Sugar Mill Road, Suite 200B
Atlanta, GA 30350
Tel: 770 640-0034 Fax: 770 640-0307

Boston

Microchip Technology Inc.
5 Mount Royal Avenue
Marlborough, MA 01752
Tel: 508 480-9990 Fax: 508 480-8575

Chicago

Microchip Technology Inc.
333 Pierce Road, Suite 180
Itasca, IL 60143
Tel: 708 285-0071 Fax: 708 285-0075

Dallas

Microchip Technology Inc.
14651 Dallas Parkway, Suite 816
Dallas, TX 75240-8809
Tel: 214 991-7177 Fax: 214 991-8588

Dayton

Microchip Technology Inc.
35 Rockridge Road
Englewood, OH 45322
Tel: 513 832-2543 Fax: 513 832-2841

Los Angeles

Microchip Technology Inc.
18201 Von Karman, Suite 455
Irvine, CA 92715
Tel: 714 263-1888 Fax: 714 263-1338

New York

Microchip Technology Inc.
150 Motor Parkway, Suite 416
Hauppauge, NY 11788
Tel: 516 273-5305 Fax: 516 273-5335

AMERICAS (continued)

San Jose

Microchip Technology Inc.
2107 North First Street, Suite 590
San Jose, CA 95131
Tel: 408 436-7950 Fax: 408 436-7955

ASIA/PACIFIC

Hong Kong

Microchip Technology
Unit No. 3002-3004, Tower 1
Metroplaza
223 Hing Fong Road
Kwai Fong, N.T. Hong Kong
Tel: 852 2 401 1200 Fax: 852 2 401 3431

Korea

Microchip Technology
168-1, Youngbo Bldg. 3 Floor
Samsung-Dong, Kangnam-Ku,
Seoul, Korea
Tel: 82 2 554 7200 Fax: 82 2 558 5934

Singapore

Microchip Technology
200 Middle Road
#10-03 Prime Centre
Singapore 188980
Tel: 65 334 8870 Fax: 65 334 8850

Taiwan

Microchip Technology
10F-1C 207
Tung Hua North Road
Taipei, Taiwan, ROC
Tel: 886 2 717 1715 Fax: 886 2 545 0139

EUROPE

United Kingdom

Arizona Microchip Technology Ltd.
Unit 6, The Courtyard
Meadow Bank, Furlong Road
Bourne End, Buckinghamshire SL8 5AJ
Tel: 44 0 1628 851077 Fax: 44 0 1628 850259

France

Arizona Microchip Technology SARL
2 Rue du Buisson aux Fraises
91300 Massy - France
Tel: 33 1 69 53 63 20 Fax: 33 1 69 30 90 79

Germany

Arizona Microchip Technology GmbH
Gustav-Heinemann-Ring 125
D-81739 Muenchen, Germany
Tel: 49 89 627 144 0 Fax: 49 89 627 144 44

Italy

Arizona Microchip Technology SRL
Centro Direzionale Colleoni
Palazzo Pegaso Ingresso No. 2
Via Paracelso 23, 20041
Agrate Brianza (MI) Italy
Tel: 39 039 689 9939 Fax: 39 039 689 9883

JAPAN

Microchip Technology Intl. Inc.
Benex S-1 6F
3-18-20, Shin Yokohama
Kohoku-Ku, Yokohama
Kanagawa 222 Japan
Tel: 81 45 471 6166 Fax: 81 45 471 6122

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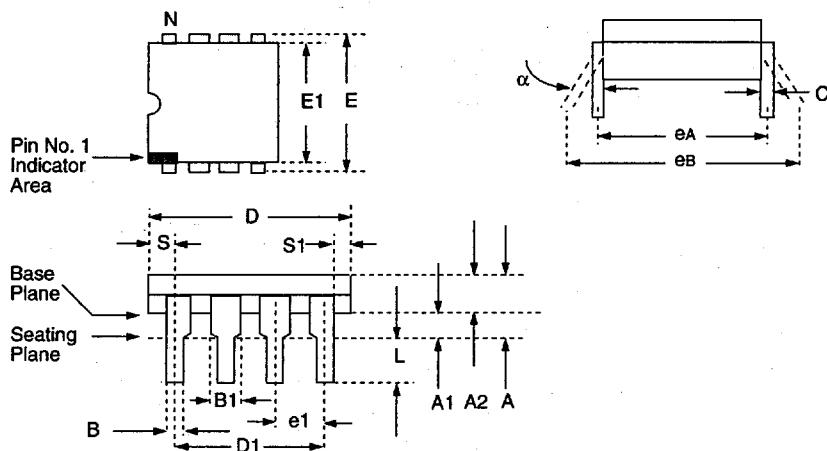
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Packaging Diagrams and Parameters

Package Type: 8-Lead Plastic Dual In-line (300 mil)



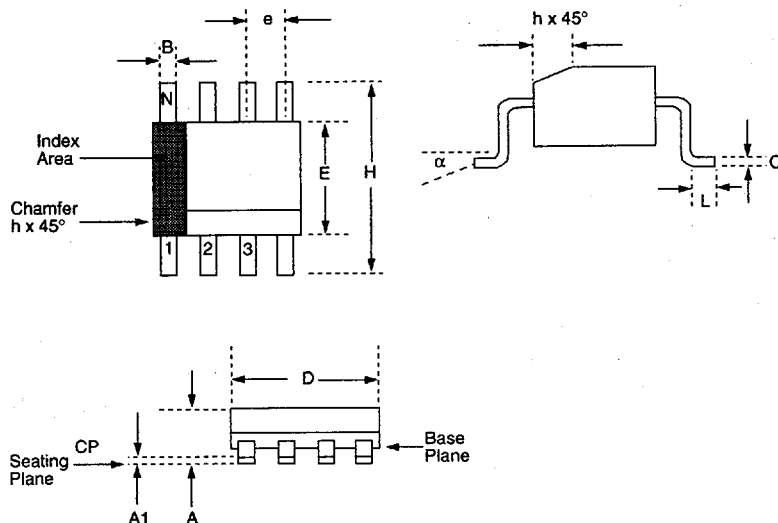
Package Group: Plastic Dual In-Line (PLA)						
Symbol	Millimeters			Inches		
	Min	Max	Notes	Min	Max	Notes
α	0°	10°		0°	10°	
A	—	4.064		—	0.160	
A1	0.381	—		0.015	—	
A2	3.048	3.810		0.120	0.150	
B	0.355	0.559		0.014	0.022	
B1	1.397	1.651		0.055	0.065	
C	0.203	0.381	Typical	0.008	0.015	Typical
D	9.017	10.922		0.355	0.430	
D1	7.620	7.620	Reference	0.300	0.300	Reference
E	7.620	8.255		0.300	0.325	
E1	6.096	7.112		0.240	0.280	
e1	2.489	2.591	Typical	0.098	0.102	Typical
eA	7.620	7.620	Reference	0.300	0.300	Reference
eB	7.874	9.906		0.310	0.390	
L	3.048	3.556		0.120	0.140	
N	8	8		8	8	
S	0.889	—		0.035	—	
S1	0.254	—		0.010	—	



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Packaging Diagrams and Parameters

Package Type: 8-Lead Plastic Surface Mount (SOIC - Narrow, 150 mil Body)



Package Group: Plastic SOIC (SN)						
Symbol	Millimeters			Inches		
	Min	Max	Notes	Min	Max	Notes
α	0°	8°		0°	8°	
A	1.371	1.728		0.054	0.068	
A1	0.101	0.249		0.004	0.010	
B	0.355	0.483		0.014	0.019	
C	0.190	0.249		0.007	0.010	
D	4.800	4.979		0.189	0.196	
E	3.810	3.988		0.150	0.157	
e	1.270	1.270	Typical	0.050	0.050	Typical
H	5.816	6.198		0.229	0.244	
h	0.381	0.762		0.015	0.030	
L	0.508	1.016		0.020	0.040	
N	8	8		8	8	
CP	—	0.102		—	0.004	